

v01.0205

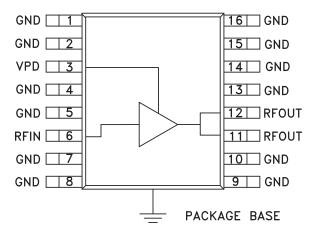


Typical Applications

The HMC453QS16G / HMC453QS16GE is ideal for applications requiring a high dynamic range amplifier:

- GSM, GPRS & EDGE
- CDMA & W-CDMA
- CATV/Cable Modem
- Fixed Wireless & WLL

Functional Diagram



InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

Features

Output IP3: +51 dBm 21.5 dB Gain @ 400 MHz 8 dB Gain @ 2100 MHz 45% PAE @ +32 dBm Pout +25 dBm CDMA2000 Channel Power@ -45 dBc ACP Single +5V Supply Integrated Power Control (VPD) QSOP16G SMT Package: 29.4 mm²

General Description

The HMC453QS16G & HMC453QS16GE are high dynamic range GaAs InGaP Heterojunction Bipolar Transistor (HBT) 1.6 watt MMIC power amplifiers operating between 0.4 and 2.2 GHz. Packaged in a miniature 16 lead QSOP plastic package, the amplifier gain is typically 21.5 dB at 0.4 GHz and 8 dB at 2.1 GHz. Utilizing a minimum number of external components and a single +5V supply, the amplifier output IP3 can be optimized to +47 dBm at 0.4 GHz or +51 dBm at 2.1 GHz. The power control (VPD) can be used for full power down or RF output power/ current control. The high output IP3 and PAE make the HMC453QS16G(E) ideal power amplifiers for Cellular/PCS/3G, WLL, ISM and Fixed Wireless applications.

Electrical Specifications, $T_A = +25^{\circ}C$, Vs = +5V, VPD = +5V^[1]

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range		400 - 410)		450 - 49	6		810 - 96	0	1	710 - 199	90	2	010 - 21	70	MHz
Gain	19	21.5		18	20.5		12	15		6	9		6	8		dB
Gain Variation Over Temperature		0.012	0.02		0.012	0.02		0.012	0.02		0.012	0.02		0.012	0.02	dB / °C
Input Return Loss		12			15			12			10			15		dB
Output Return Loss		10			10			15			13			18		dB
Output Power for 1dB Compression (P1dB)	29	32		29	32		29	32		28.5	31.5		30	33		dBm
Saturated Output Power (Psat)		32.25			32.25			32.5			32			33.5		dBm
Output Third Order Intercept (IP3) [2]	44	47		47	50		46	49		44	50		48	51		dBm
Noise Figure		7			8.5			7			7.5			6.5		dB
Supply Current (Icq)		725			725			725			725			725		mA
Control Current (IPD)		12			12			12			12			12		mA

[1] Specifications and data reflect HMC453QS16G measured using the respective application circuits for each designated frequency band found herein. Contact the HMC Applications Group for assistance in optimizing performance for your application.

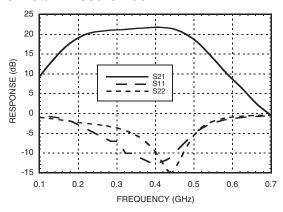
[2] Two-tone input power of -10 dBm per tone, 1 MHz spacing.

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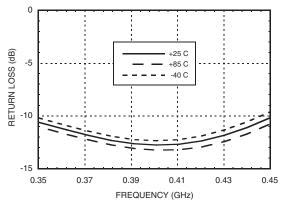




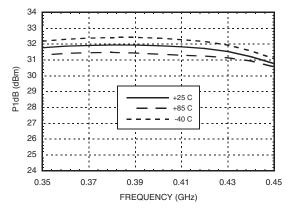
Broadband Gain & Return Loss @ 400 MHz



Input Return Loss vs. Temperature @ 400 MHz

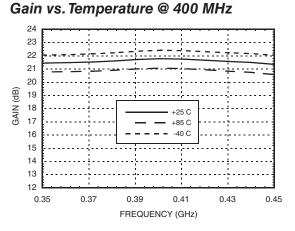


P1dB vs. Temperature @ 400 MHz

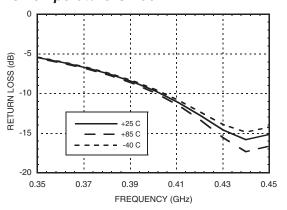


HMC453QS16G / 453QS16GE

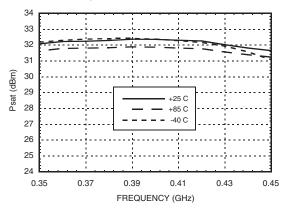
InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz



Output Return Loss vs. Temperature @ 400 MHz



Psat vs. Temperature @ 400 MHz



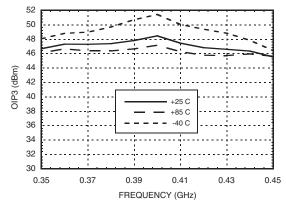
LINEAR & POWER AMPLIFIERS - SMT

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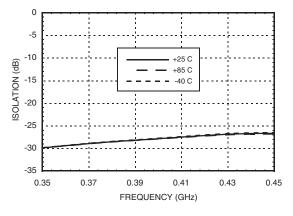




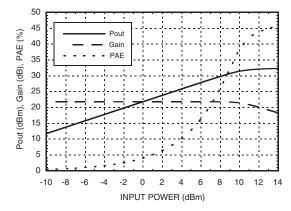
Output IP3 vs. Temperature @ 400 MHz



Reverse Isolation vs. Temperature @ 400 MHz

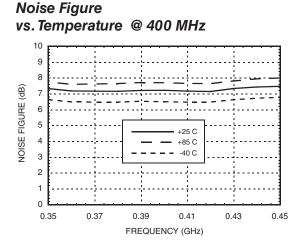


Power Compression @ 400 MHz

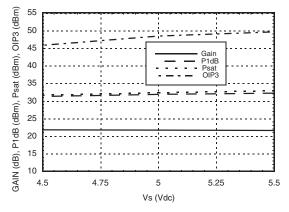


HMC453QS16G / 453QS16GE

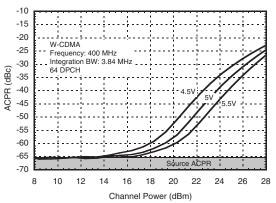
InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz



Gain, Power & IP3 vs. Supply Voltage @ 400 MHz



ACPR vs. Supply Voltage @ 400 MHz W-CDMA, 64 DPCH



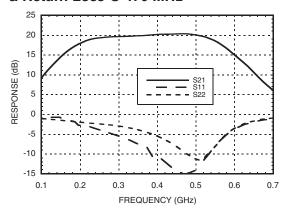
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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

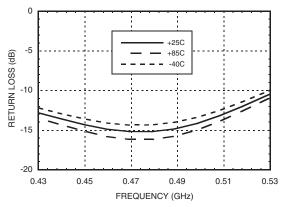


Broadband Gain & Return Loss @ 470 MHz

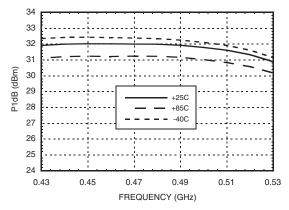


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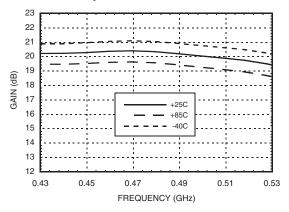
Input Return Loss vs. Temperature @ 40 MHz



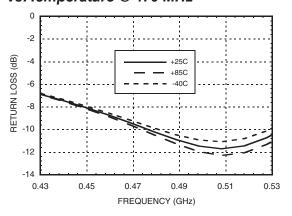
P1dB vs. Temperature @ 470 MHz



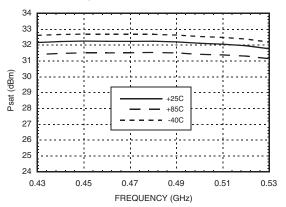
Gain vs. Temperature @ 470 MHz



Output Return Loss vs. Temperature @ 470 MHz



Psat vs. Temperature @ 470 MHz

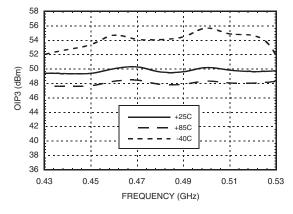


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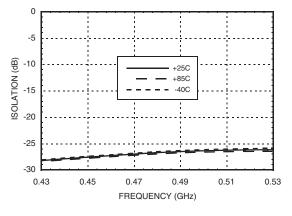




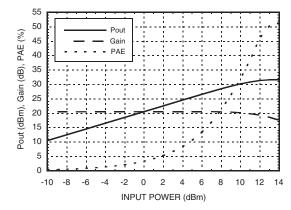
Output IP3 vs. Temperature @ 470 MHz



Reverse Isolation vs. Temperature @ 470 MHz

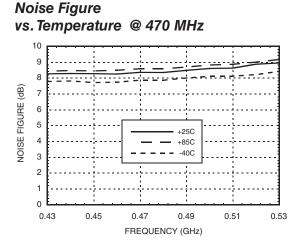


Power Compression @ 470 MHz

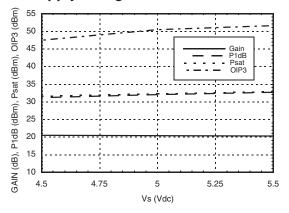


HMC453QS16G / 453QS16GE

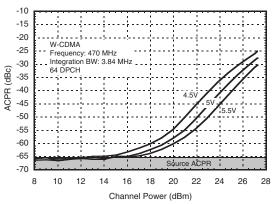
InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz



Gain, Power & IP3 vs. Supply Voltage @ 470 MHz



ACPR vs. Supply Voltage @ 470 MHz W-CDMA, 64 DPCH



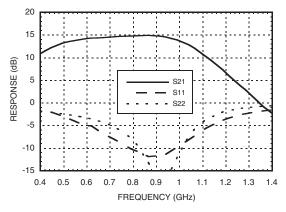
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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

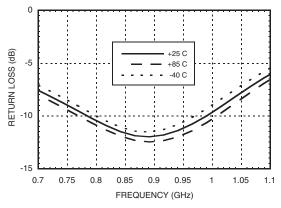


Broadband Gain & Return Loss @ 900 MHz

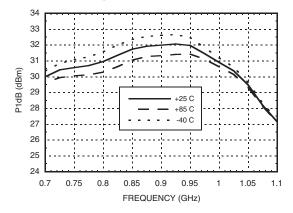


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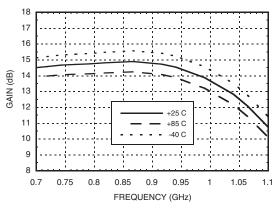
Input Return Loss vs. Temperature @ 900 MHz



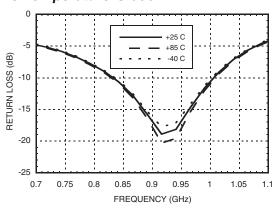
P1dB vs. Temperature @ 900 MHz



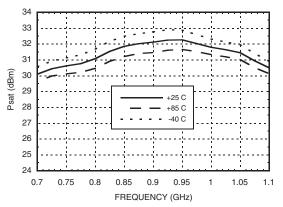




Output Return Loss vs. Temperature @ 900 MHz



Psat vs. Temperature @ 900 MHz

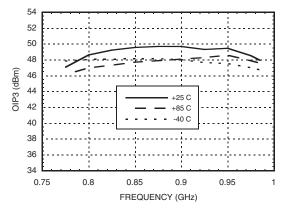


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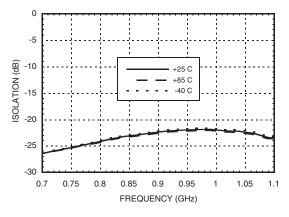




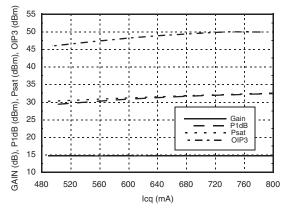
Output IP3 vs. Temperature @ 900 MHz



Reverse Isolation vs. Temperature @ 900 MHz



Gain, Power & IP3 vs. Supply Current @ 900 MHz*



* lcq is controlled by varying VPD.

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HMC453QS16G / 453QS16GE

InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

Noise Figure vs. Temperature @ 900 MHz

Gain, Power & IP3 vs. Supply Voltage @ 900 MHz

0.85

0.9

FREQUENCY (GHz)

0.95

1.05

1

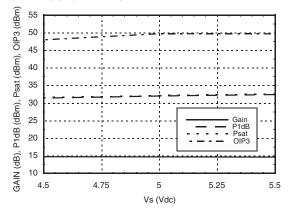
1.1

0.8

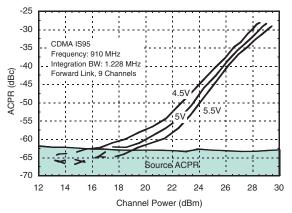
Λ

0.7

0.75



ACPR vs. Supply Voltage @ 910 MHz CDMA IS95, 9 Channels Forward

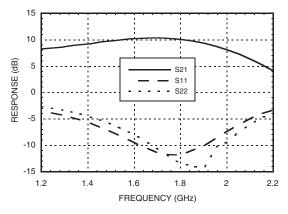




InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

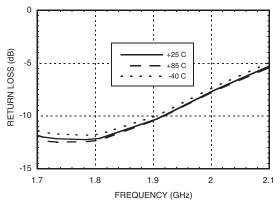


Broadband Gain & Return Loss @ 1900 MHz

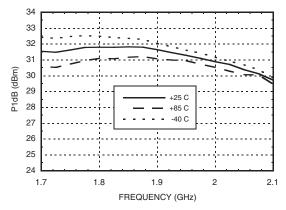


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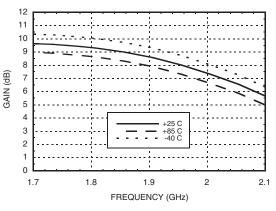
Input Return Loss vs. Temperature @ 1900 MHz



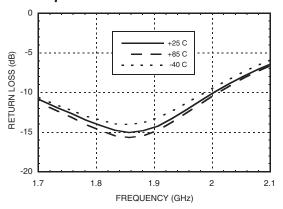
P1dB vs. Temperature @ 1900 MHz



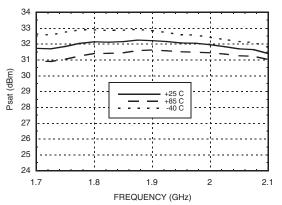




Output Return Loss vs. Temperature @ 1900 MHz



Psat vs. Temperature @ 1900 MHz



LINEAR & POWER AMPLIFIERS - SMT

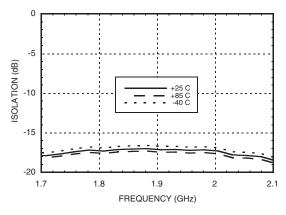
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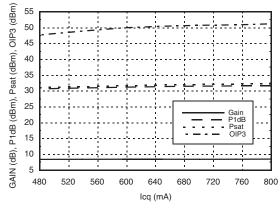


Output IP3 vs. Temperature @ 1900 MHz 52 50 48 46 44 OIP3 (dBm) 42 40 +25 C 38 +85 C -40 C 36 34 32 30 2 2.1 1.7 1.8 1.9 FREQUENCY (GHz)

Reverse Isolation vs. Temperature @ 1900 MHz



Gain, Power & IP3 vs. Supply Current @ 1900 MHz*

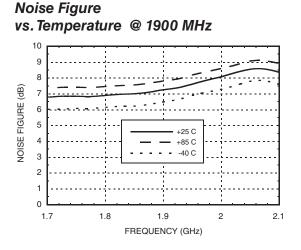


* Icq is controlled by varying VPD.

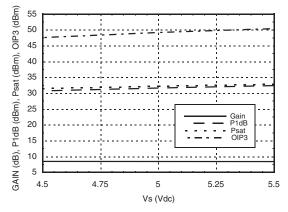
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HMC453QS16G / 453QS16GE

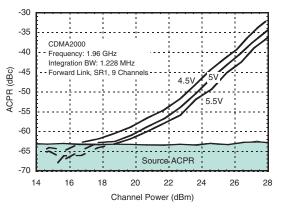
InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz



Gain, Power & IP3 vs. Supply Voltage @ 1900 MHz



ACPR vs. Supply Voltage @ 1960 MHz CDMA 2000, 9 Channels Forward





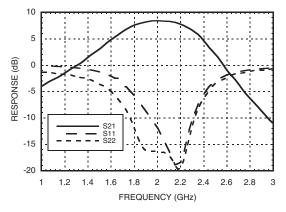
InGaP HBT 1.6 WATT POWER

AMPLIFIER, 0.4 - 2.2 GHz

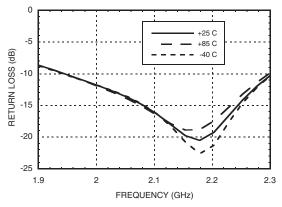
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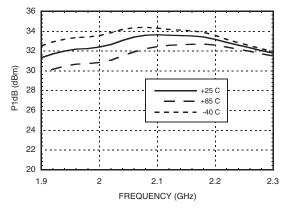
Broadband Gain & Return Loss @ 2100 MHz



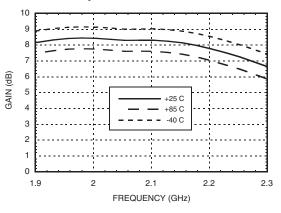
Input Return Loss vs. Temperature @ 2100 MHz



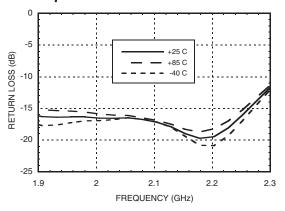
P1dB vs. Temperature @ 2100 MHz



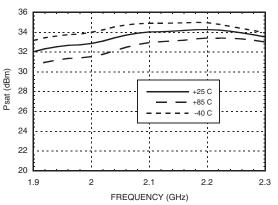
Gain vs. Temperature @ 2100 MHz



Output Return Loss vs. Temperature @ 2100 MHz



Psat vs. Temperature @ 2100 MHz

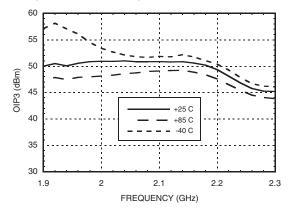


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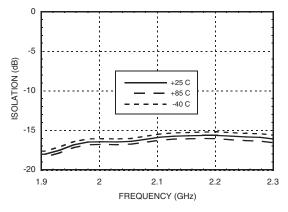




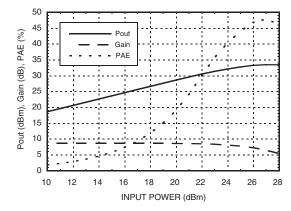
Output IP3 vs. Temperature @ 2100 MHz



Reverse Isolation vs. Temperature @ 2100 MHz

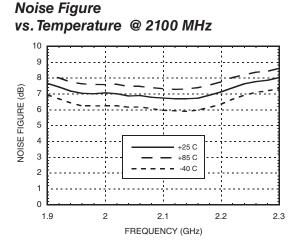


Power Compression @ 2100 MHz

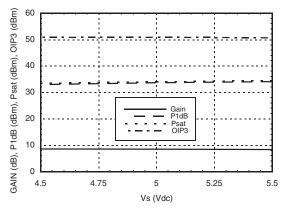


HMC453QS16G / 453QS16GE

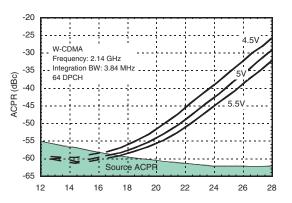
InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz



Gain, Power & IP3 vs. Supply Voltage @ 2100 MHz



ACPR vs. Supply Voltage @ 2140 MHz W-CDMA, 64 DPCH



LINEAR & POWER AMPLIFIERS - SM

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InGaP HBT 1.6 WATT POWER

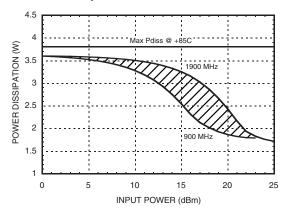
AMPLIFIER, 0.4 - 2.2 GHz

v01.0205



Power Dissipation

Outline Drawing

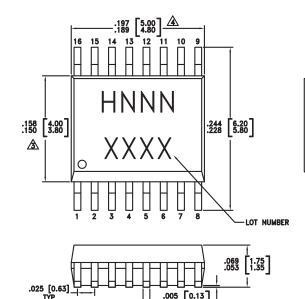


Absolute Maximum Ratings

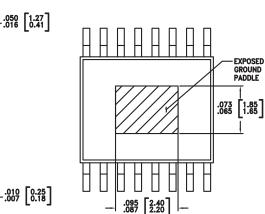
Collector Bias Voltage (Vcc)	+6.0 Vdc		
Control Voltage (Vpd)	+5.4 Vdc		
RF Input Power (RFIN)(Vs = Vpd = +5Vdc)	+32 dBm		
Junction Temperature	150 °C		
Continuous Pdiss (T = 85 °C) (derate 58.5 mW/°C above 85 °C)	3.8 W		
Thermal Resistance (junction to ground paddle)	17.1 °C/W		
Storage Temperature	-65 to +150 °C		
Operating Temperature	-40 to +85 °C		



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**



8. .050 [1.27]



NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY

DIMENSIONS ARE IN INCHES [MILLIMETERS]

A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.

5. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

.012 0.30 TYP

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC453QS16G	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H453 XXXX
HMC453QS16GE	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	<u>H453</u> XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz

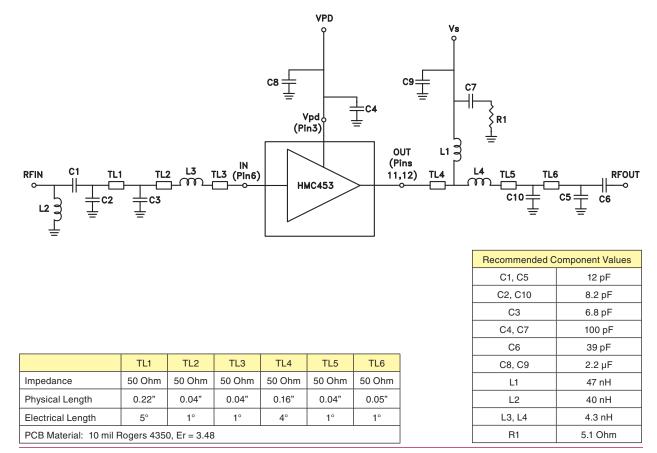
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 4, 5, 7-10, 13-16	GND	These pins & package bottom must be connected to RF/DC ground.	
3	VPD	Power control pin. For maximum power, this pin should be connected to 5V. A higher voltage is not recommended. For lower idle current, this voltage can be reduced.	VPD 0 300 =
6	RFIN	This pin is DC coupled. Off chip matching components are required. See Application Circuit herein.	
11, 12	RFOUT	RF output and DC Bias input for the output amplifier stage. Off chip matching components are required. See Application Circuit herein.	

v01.0205

400 MHz Application Circuit

This circuit was used to specify the performance for 400-410 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



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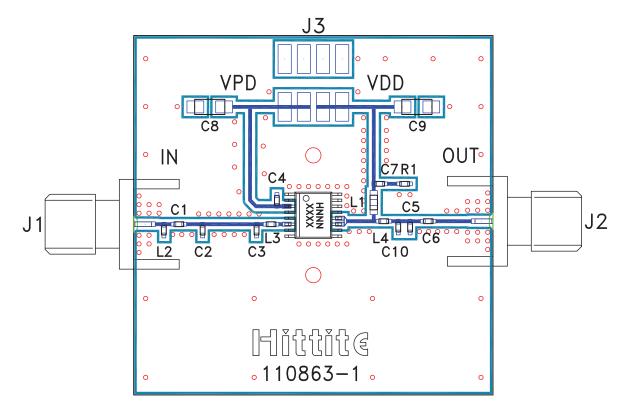


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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.4 - 2.2 GHz



400 MHz Evaluation PCB



List of Materials for Evaluation PCB 110865-400 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1, C5	12 pF Capacitor, 0402 Pkg.
C2, C10	8.2 pF Capacitor, 0402 Pkg.
C3	6.8 pF Capacitor, 0402 Pkg.
C4, C7	100 pF Capacitor, 0402 Pkg.
C6	39 pF Capacitor, 0402 Pkg.
C8, C9	2.2 µF Capacitor, Tantalum
L1	47 nH Inductor, 0603 Pkg.
L2	40 nH Inductor, 0402 Pkg.
L3, L4	4.3 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC453QS16G / HMC453QS16GE Linear Amp
PCB [2]	110863 Evaluation PCB, 10 mils

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

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The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

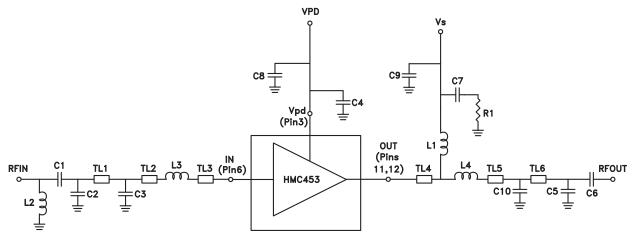


ROHS V EARTH FRIENDLY

InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz

470 MHz Application Circuit

This circuit was used to specify the performance for 450-496 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



Recommended C	Recommended Component Values				
C1	12 pF				
C2	8.2 pF				
C3	6.8 pF				
C4, C7	100 pF				
C5	10 pF				
C6	39 pF				
C8, C9	2.2 µF				
C10	5.6 pF				
L1	47 nH				
L2	40 nH				
L3, L4	4.3 nH				
R1	5.1 Ohm				

	TIA	TLO	TLO	T I 4	T 1 C	TLO
	TL1	TL2	TL3	TL4	TL5	TL6
Impedance	50 Ohm	50 Ohm	50 Ohm	50 Ohm	50 Ohm	50 Ohm
Physical Length	0.22"	0.04"	0.04"	0.16"	0.04"	0.05"
Electrical Length	6°	1°	1°	4°	1°	1°
PCB Material: 10 mil Rogers 4350, Er = 3.48						

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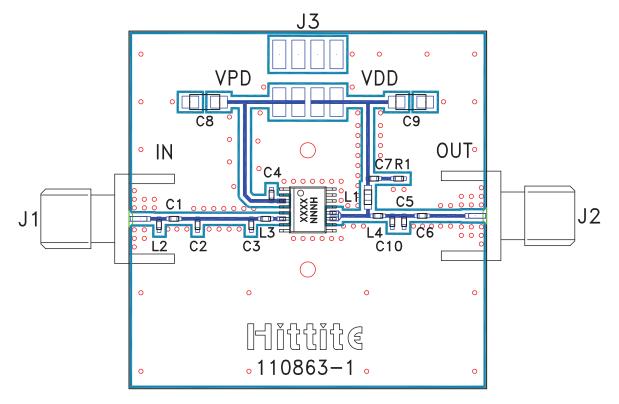


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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz



470 MHz Evaluation PCB



List of Materials for Evaluation PCB 110976-470 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	12 pF Capacitor, 0402 Pkg.
C2	8.2 pF Capacitor, 0402 Pkg.
C3	6.8 pF Capacitor, 0402 Pkg.
C4, C7	100 pF Capacitor, 0402 Pkg.
C5	10 pF Capacitor, 0402 Pkg.
C6	39 pF Capacitor, 0402 Pkg.
C8, C9	2.2 µF Capacitor, Tantalum
C10	5.6 pF Capacitor, 0402 Pkg.
L1	47 nH Inductor, 0603 Pkg.
L2	40 nH Inductor, 0402 Pkg.
L3, L4	4.3 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC453QS16G / HMC453QS16GE Linear Amp
PCB [2]	110863 Evaluation PCB, 10 mils

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

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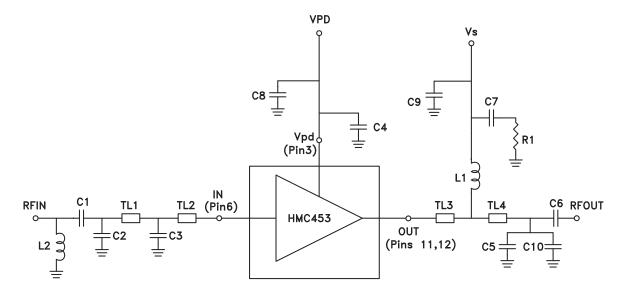
ROHS V

InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz

900 MHz Application Circuit

This circuit was used to specify the performance for 810-960 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.

v01.0205



	TL1	TL2	TL3	TL4		
Impedance	50 Ohm	50 Ohm	50 Ohm	50 Ohm		
Physical Length	0.26"	0.08"	0.12"	0.15"		
Electrical Length	14°	4°	6°	8°		
PCB Material: 10 mil Rogers 4350, Er = 3.48						

Recommended Component Values					
C1	5 pF				
C2, C3	3.3 pF				
C4, C7	100 pF				
C5	8.2 pF				
C6	56 pF				
C8, C9	2.2 μF				
C10	1 pF				
L1	30 nH				
L2	20 nH				
R1	5.6 Ohm				

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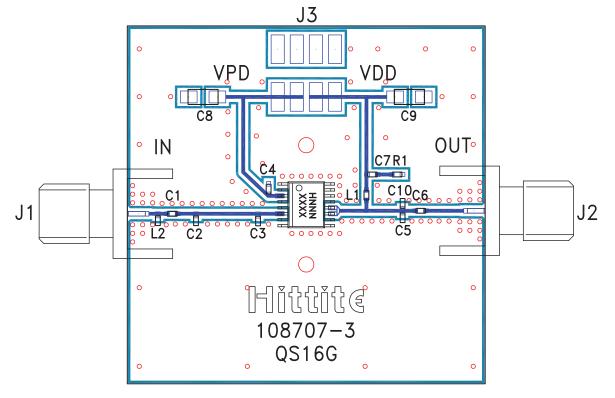


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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz



900 MHz Evaluation PCB



List of Materials for Evaluation PCB 108709-900 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	5.0 pF Capacitor, 0402 Pkg.
C2, C3	3.3 pF Capacitor, 0402 Pkg.
C4, C7	100 pF Capacitor, 0402 Pkg.
C5	8.2 pF Capacitor, 0402 Pkg.
C6	56 pF Capacitor, 0402 Pkg.
C8, C9	2.2 µF Capacitor, Tantalum
C10	1.0 pF Capacitor, 0402 Pkg.
L1	30 nH Inductor, 0402 Pkg.
L2	20 nH Inductor, 0402 Pkg.
R1	5.6 Ohm Resistor, 0402 Pkg.
U1	HMC453QS16G / HMC453QS16GE Linear Amp
PCB ^[2]	108707 Evaluation PCB, 10 mils

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

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The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

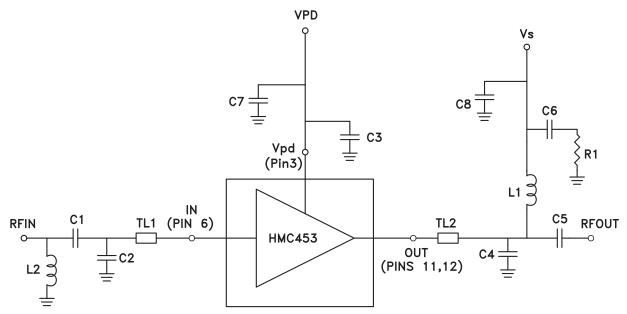


ROHS V EARTH FRIENDLY

InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz

1900 MHz Application Circuit

This circuit was used to specify the performance for 1710-1990 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.



	TL1	TL2			
Impedance	50 Ohm	50 Ohm			
Physical Length	0.04"	0.04"			
Electrical Length	4°	4°			
PCB Material: 10 mil Rogers 4350, Er = 3.48					

Recommended Component Values		
C1	0.8 pF	
C2	1.2 pF	
C3, C6	100 pF	
C4	4.7 pF	
C5	15 pF	
C7, C8	2.2 μF	
L1	18 nH	
L2	20 nH	
R1	5.6 Ohms	

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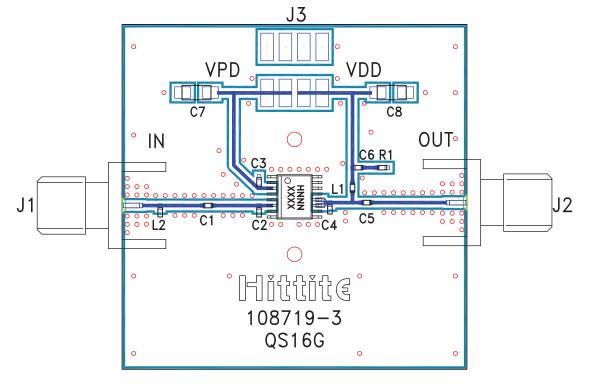


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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz



1900 MHz Evaluation PCB



List of Materials for Evaluation PCB 108721-1900 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	0.8 pF Capacitor, 0402 Pkg.
C2	1.2 pF Capacitor, 0402 Pkg.
C3, C6	100 pF Capacitor, 0402 Pkg.
C4	4.7 pF Capacitor, 0402 Pkg.
C5	15 pF Capacitor, 0402 Pkg.
C7, C8	2.2 µF Capacitor, Tantalum
L1	18 nH Inductor, 0402 Pkg.
L2	20 nH Inductor, 0402 Pkg.
R1	5.6 Ohm Resistor, 0402 Pkg.
U1	HMC453QS16G / HMC453QS16GE Linear Amp
PCB [2]	108719 Evaluation PCB, 10 mils

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

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The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.



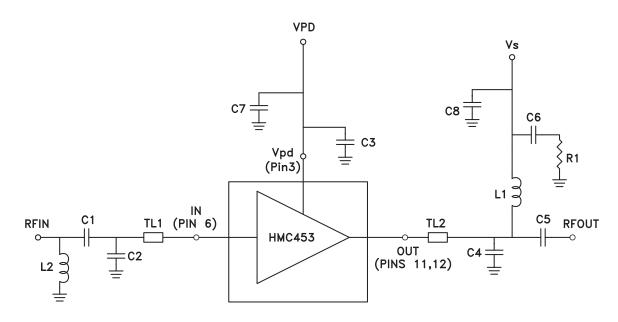
ROHS V EARTH FRIENDLY

InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz

2100 MHz Application Circuit

This circuit was used to specify the performance for 2100-2170 MHz operation. Contact the HMC Applications Group for assistance in optimizing performance for your application.

v01.0205



	TL1	TL2
Impedance	50 Ohm	50 Ohm
Physical Length	0.04"	0.04"
Electrical Length	5°	5°
PCB Material: 10 mil Rogers 4350, Er = 3.48		

Recommended Component Values		
C1	0.8 pF	
C2	1 pF	
C3, C6	100 pF	
C4	3.9 pF	
C5	15 pF	
C7, C8	2.2 µF	
L1	12 nH	
L2	20 nH	
R1	5.1 Ohm	

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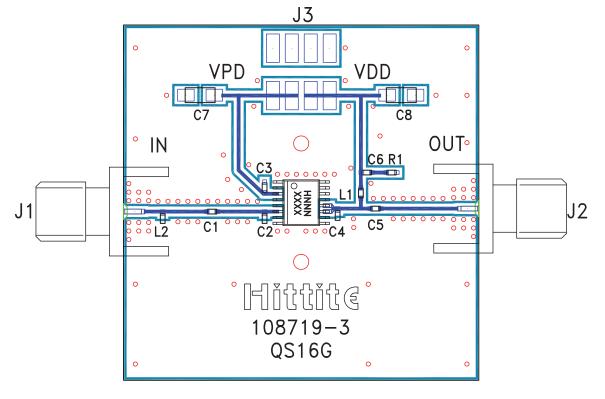


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InGaP HBT 1.6 WATT POWER AMPLIFIER, 0.2 - 2.4 GHz



2100 MHz Evaluation PCB



List of Materials for Evaluation PCB 109994-2100 [1]

Item	Description
J1 - J2	PCB Mount SMA Connector
J3	2 mm DC Header
C1	0.8 pF Capacitor, 0402 Pkg.
C2	1.0 pF Capacitor, 0402 Pkg.
C3, C6	100 pF Capacitor, 0402 Pkg.
C4	3.9 pF Capacitor, 0402 Pkg.
C5	15 pF Capacitor, 0402 Pkg.
C7, C8	2.2 µF Capacitor, Tantalum
L1	12 nH Inductor, 0402 Pkg.
L2	20 nH Inductor, 0402 Pkg.
R1	5.1 Ohm Resistor, 0402 Pkg.
U1	HMC453QS16G / HMC453QS16GE Linear Amp
PCB [2]	108719 Evaluation PCB, 10 mils

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350, Er = 3.48

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The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.